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DATA SHEET

TDA8567Q

4 × 25 W BTL quad car radio power amplifier

Product specification

Supersedes data of 1997 Feb 12

File under Integrated Circuits, IC01

1998 Sep 23

Philips
Semiconductors

PHILIPS

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

FEATURES

- Requires very few external components
- High output power
- Low output offset voltage
- Fixed gain
- Diagnostic facility (distortion, short-circuit and temperature pre-warning)
- Good ripple rejection
- Mode select switch (operating, mute and standby)
- Load dump protection
- Short-circuit safe to ground and to V_P and across the load
- Low power dissipation in any short-circuit condition
- Thermally protected
- Reverse polarity safe
- Electrostatic discharge protection
- No switch-on/switch-off plop
- Flexible leads
- Low thermal resistance
- Pin compatible with the TDA8568Q, except for the gain.

GENERAL DESCRIPTION

The TDA8567Q is an integrated class-B output amplifier in a 23-lead Single-In-Line (SIL) plastic power package. It contains four amplifiers in BTL configuration, each with a gain of 26 dB. The output power is 4 × 25 W in a 4 Ω load.

APPLICATIONS

- The device is primarily developed for car radio applications.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_P	operating supply voltage		6	14.4	18	V
I_{ORM}	repetitive peak output current		–	–	7.5	A
$I_{q(tot)}$	total quiescent current		–	230	–	mA
I_{stb}	standby current		–	0.2	100	µA
I_{sw}	switch-on current		–	–	80	µA
$|Z_i|$	input impedance		25	30	–	kΩ
P_o	output power	THD = 10%	–	25	–	W
SVRR	supply voltage ripple rejection	$R_s = 0$ Ω	–	60	–	dB
α_{cs}	channel separation	$R_s = 10$ kΩ	–	50	–	dB
G_v	closed loop voltage gain		25	26	27	dB
$V_{n(o)}$	noise output voltage	$R_s = 0$ Ω	–	–	120	µV
$|\Delta V_O|$	DC output offset voltage		–	–	150	mV

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
TDA8567Q	DBS23P	plastic DIL-bent-SIL power package; 23 leads (straight lead length 3.2 mm)	SOT411-1

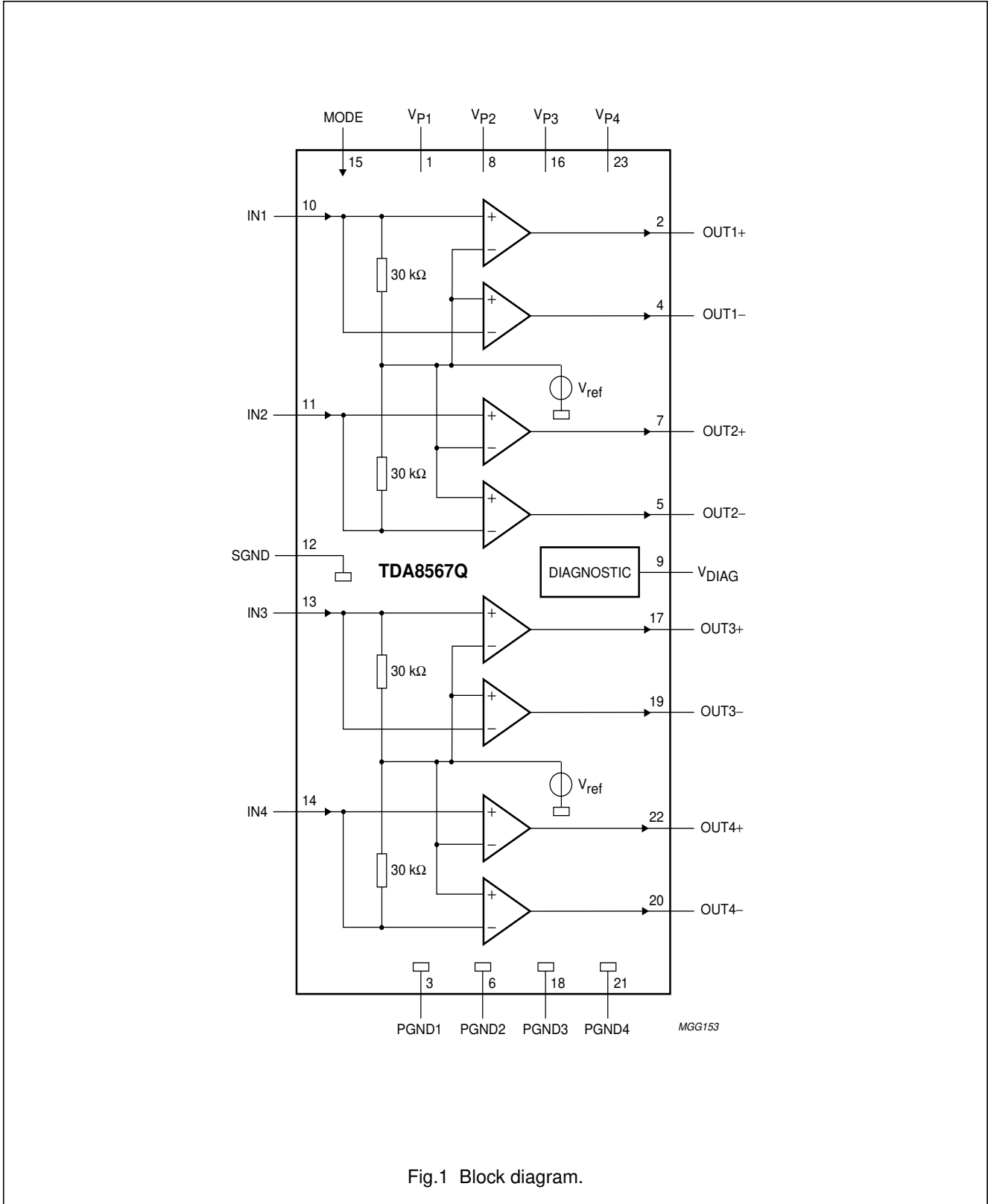# 4 × 25 W BTL quad car radio power amplifier

TDA8567Q

BLOCK DIAGRAM

Fig.1 Block diagram.

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

PINNING

| SYMBOL	PIN	DESCRIPTION
V_{P1}	1	supply voltage 1
OUT1+	2	output 1+
PGND1	3	power ground 1
OUT1−	4	output 1−
OUT2−	5	output 2−
PGND2	6	power ground 2
OUT2+	7	output 2+
V_{P2}	8	supply voltage 2
V_{DIAG}	9	diagnostic output
IN1	10	input 1
IN2	11	input 2
SGND	12	signal ground
IN3	13	input 3
IN4	14	input 4
MODE	15	mode select switch input
V_{P3}	16	supply voltage 3
OUT3+	17	output 3+
PGND3	18	power ground 3
OUT3−	19	output 3−
OUT4−	20	output 4−
PGND4	21	power ground 4
OUT4+	22	output 4+
V_{P4}	23	supply voltage 4
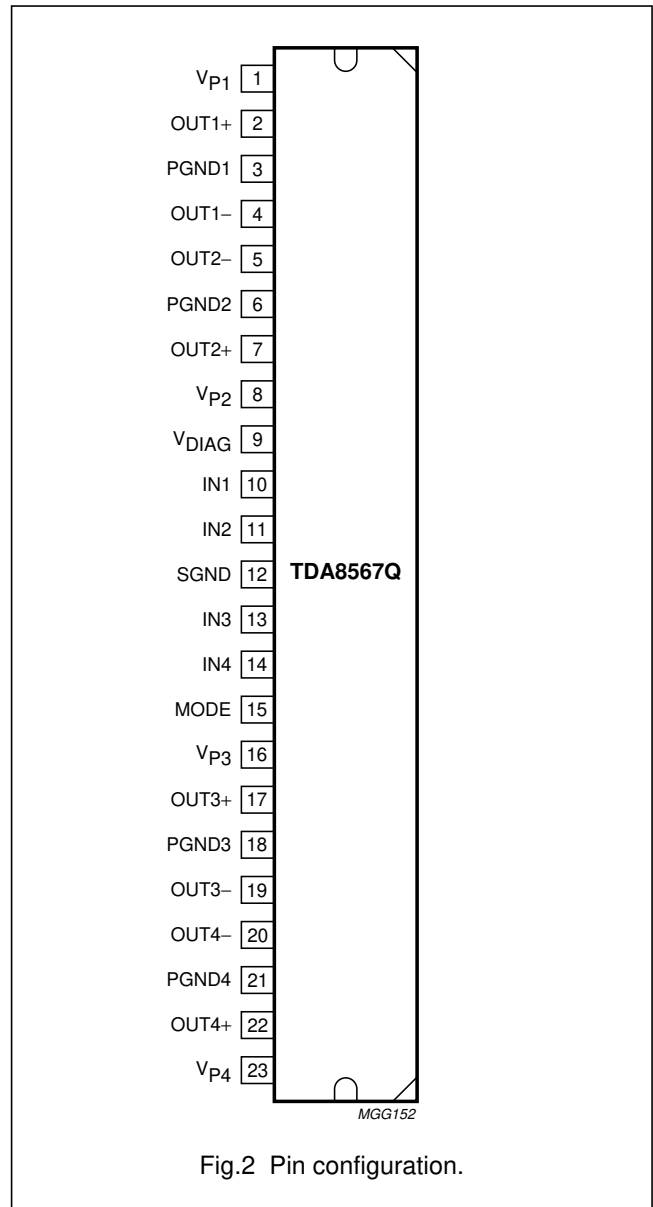
Fig.2 Pin configuration.

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

FUNCTIONAL DESCRIPTION

The TDA8567Q contains four identical amplifiers which can be used for bridge applications. The gain of each amplifier is fixed at 26 dB.

Mode select switch (pin 15)

- Standby: low supply current (<100 μA)
- Mute: input signal suppressed
- Operating: normal on condition.

Since this pin has a low input current (<80 μA), a low cost supply switch can be applied.

To avoid switch-on plops, it is advised to keep the amplifier in the mute mode during ≥150 ms (charging of the input capacitors at pins 10, 11, 13 and 14). When switching from standby to mute, the slope should be at least 18 V/s.

This can be realized by:

- Microprocessor control
- External timing circuit (see Fig.3).

Diagnostic output (pin 9)

DYNAMIC DISTORTION DETECTOR (DDD)

At the onset of clipping of one or more output stages, the dynamic distortion detector becomes active and pin 9 goes LOW. This information can be used to drive a sound processor or DC volume control to attenuate the input signal and so limit the distortion. The output level of pin 9 is independent of the number of channels that are clipping (see Fig.4).

SHORT-CIRCUIT DIAGNOSTIC

When a short-circuit occurs at one or more outputs to ground or to the supply voltage, the output stages are switched off until the short-circuit is removed and the device is switched on again, with a delay of approximately 10 ms after removal of the short-circuit. During this short-circuit condition, pin 9 is continuously LOW.

When a short-circuit occurs across the load of one or more channels, the output stages are switched off during approximately 10 ms. After that time it is checked during approximately 50 μs to determine whether the short-circuit is still present.
Due to this duty cycle of 50 μs/10 ms the average current consumption during this short-circuit condition is very low.

During this short-circuit condition, pin 9 is LOW for 10 ms and HIGH for 50 μs (see Fig.5). The protection circuits of all channels are coupled. This means that if a short-circuit condition occurs in **one** of the channels, **all** channels are switched off. Consequently, the power dissipation in any short-circuit condition is very low.

TEMPERATURE PRE-WARNING

When the virtual junction temperature T_{vj} reaches 145 °C, pin 9 goes LOW.

OPEN COLLECTOR OUTPUTS

The diagnostic pin has an open collector output, so more devices can be tied together. An external pull-up resistor is needed.

Fig.3 Mode select switch circuitry.

Fig.4 Distortion detector waveform.
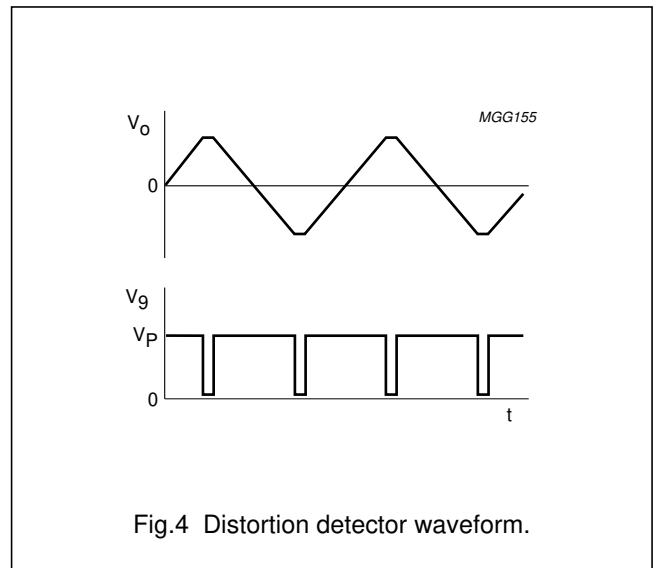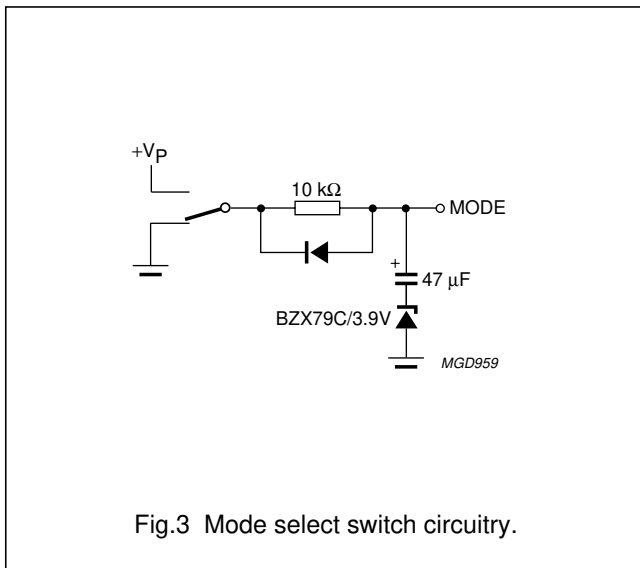
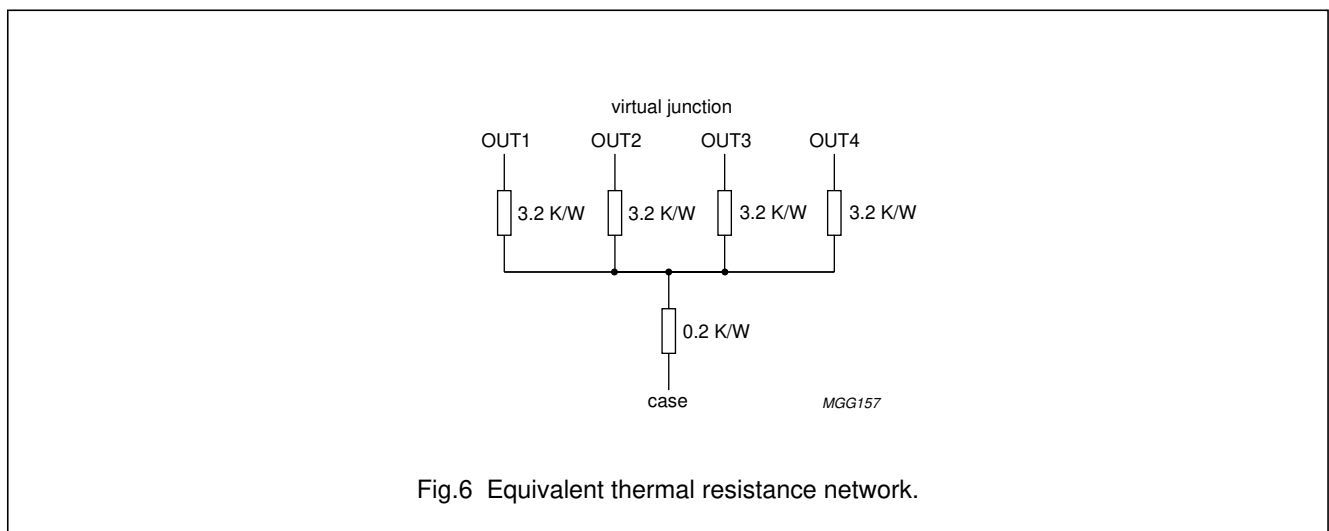## 4 × 25 W BTL quad car radio power amplifier
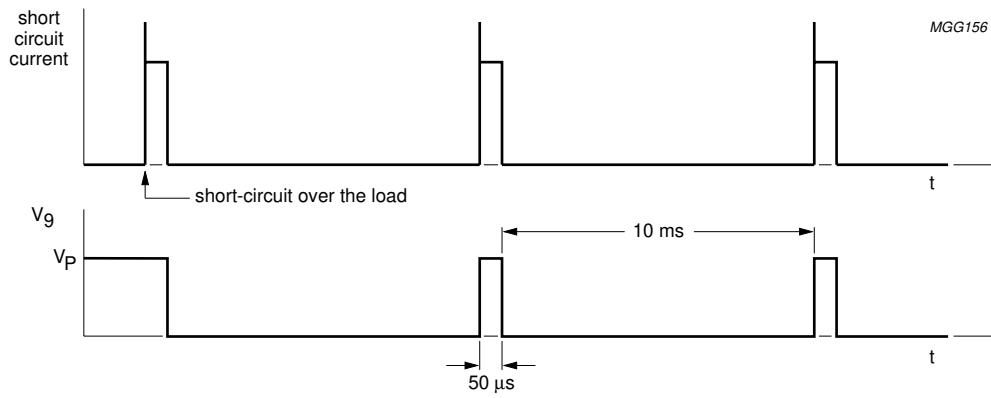
Fig.5 Short-circuit waveform.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_P	supply voltage	operating	–	18	V
		non-operating	–	30	V
		load dump protection; during 50 ms; $t_r \geq 2.5$ ms	–	45	V
$V_{sc(safe)}$	short-circuit safe voltage		–	18	V
V_{rp}	reverse polarity voltage		–	6	V
I_{OSM}	non-repetitive peak output current		–	10	A
I_{ORM}	repetitive peak output current		–	7.5	A
P_{tot}	total power dissipation		–	60	W
T_{stg}	storage temperature		–55	+150	°C
T_{amb}	operating ambient temperature		–40	+85	°C
T_{vj}	virtual junction temperature		–	150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient in free air	40	K/W
$R_{th\ j-c}$	thermal resistance from junction to case (see Fig.6)	1	K/W

Fig.6 Equivalent thermal resistance network.

QUALITY SPECIFICATION

In accordance with *"SNW-FQ-611E"*. The number of the quality specification can be found in the *"Quality Reference Handbook"*. The handbook can be ordered using the code 9397 750 00192.

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

DC CHARACTERISTICS

V_P = 14.4 V; T_{amb} = 25 °C; measured in Fig.7; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply						
V_P	supply voltage	note 1	6	14.4	18	V
$I_{q(tot)}$	total quiescent current	$R_L = \infty$	–	230	360	mA
Operating condition						
V_{15}	mode select switch level		8.5	–	V_P	V
I_{15}	mode select switch current	V_{15} = 14.4 V	–	30	80	µA
V_O	output voltage	note 2	–	7.0	–	V
$|\Delta V_O|$	output offset voltage		–	–	150	mV
Mute condition						
V_{15}	mode select switch level		3.3	–	6.4	V
V_O	output voltage	note 2	–	7.0	–	V
$|\Delta V_O|$	output offset voltage		–	–	150	mV
Standby condition						
V_{15}	mode select switch level		0	–	2	V
I_{stb}	standby current		–	0.2	100	µA
Diagnostic						
V_9	diagnostic output voltage	during any fault condition	–	–	0.6	V
T_{vj}	temperature pre-warning	V_9 = 0.6 V	–	145	–	°C

Notes

1. The circuit is DC adjusted at V_P = 6 to 18 V and AC operating at V_P = 8.5 to 18 V.

2. At 18 V < V_P < 30 V the DC output voltage $\leq \frac{1}{2}V_P$.

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

AC CHARACTERISTICS

V_P = 14.4 V; R_L = 4 Ω; f = 1 kHz; T_{amb} = 25 °C; measured in Fig.7; unless otherwise specified.

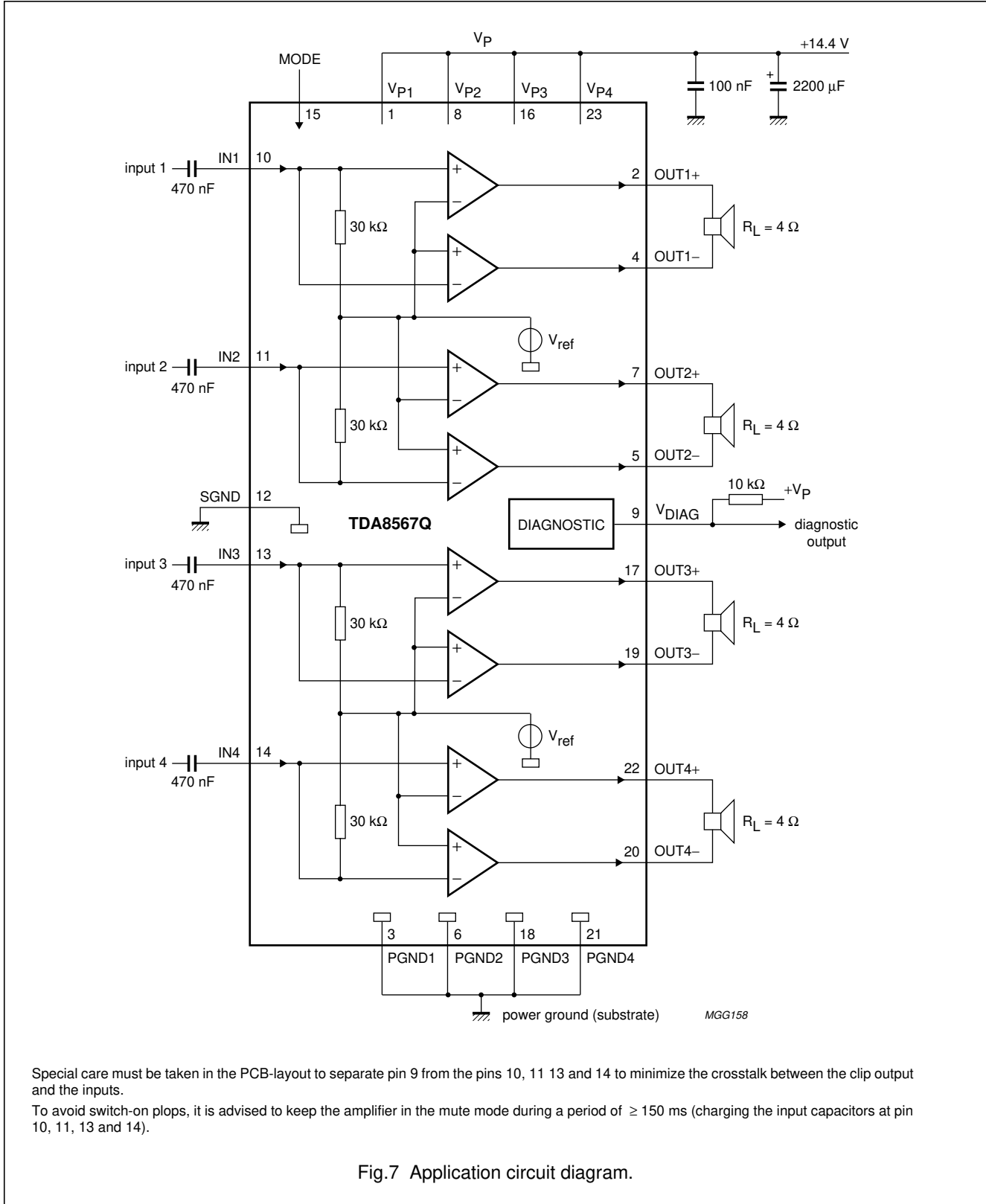| SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
P_o	output power	THD = 0.5%	16	19	–	W
		THD = 10%	21	25	–	W
		THD = 30%	28	35	–	W
		V_P = 13.2 V; THD = 0.5%	–	15	–	W
		V_P = 13.2 V; THD = 10%	–	21	–	W
THD	total harmonic distortion	P_o = 1 W	–	0.05	–	%
		$V_9 \leq$ 0.6 V; note 8	–	10	–	%
B_p	power bandwidth	THD = 0.5%; P_o = −1 dB with respect to 16 W	–	20 to 20000	–	Hz
$f_{ro(l)}$	low frequency roll-off	at −1 dB; note 1	–	25	–	Hz
$f_{ro(h)}$	high frequency roll-off	at −1 dB	20	–	–	kHz
G_v	closed loop voltage gain		25	26	27	dB
SVRR	supply voltage ripple rejection	on; note 2	50	–	–	dB
		mute; note 2	50	–	–	dB
		standby; note 2	80	–	–	dB
$|Z_i|$	input impedance		25	30	38	kΩ
$V_{n(o)}$	noise output voltage	on; note 3	–	85	120	μV
		on; note 4	–	100	–	μV
		mute; note 5	–	60	–	μV
α_{cs}	channel separation	note 6	45	–	–	dB
$|\Delta G_v|$	channel unbalance		–	–	1	dB
V_o	output signal in mute	note 7	–	–	2	mV

Notes

1. Frequency response externally fixed.

2. V_{ripple} = $V_{ripple(max)}$ = 2 V (p-p); R_s = 0 Ω.

3. B = 20 Hz to 20 kHz; R_s = 0 Ω.

4. B = 20 Hz to 20 kHz; R_s = 10 kΩ.

5. B = 20 Hz to 20 kHz; independent of R_s.

6. P_O = 16 W; R_s = 10 kΩ.

7. V_i = $V_{i(max)}$ = 1 V (RMS).

8. Dynamic Distortion Detector (DDD) active, pin 9 is set to logic 0.

4 × 25 W BTL quad car radio power amplifier
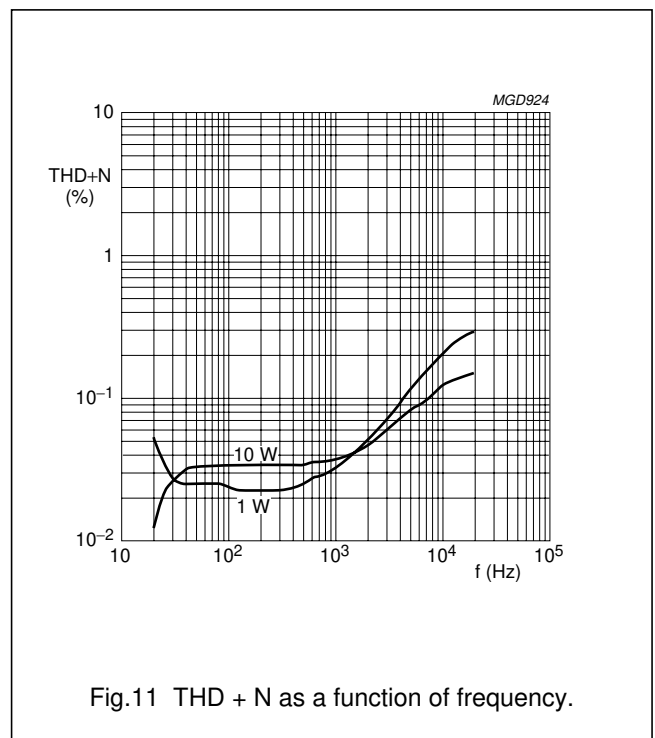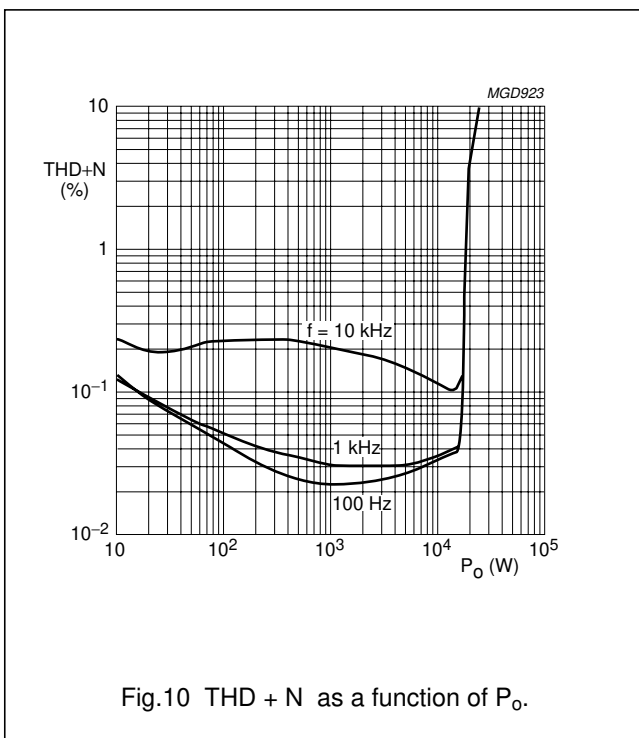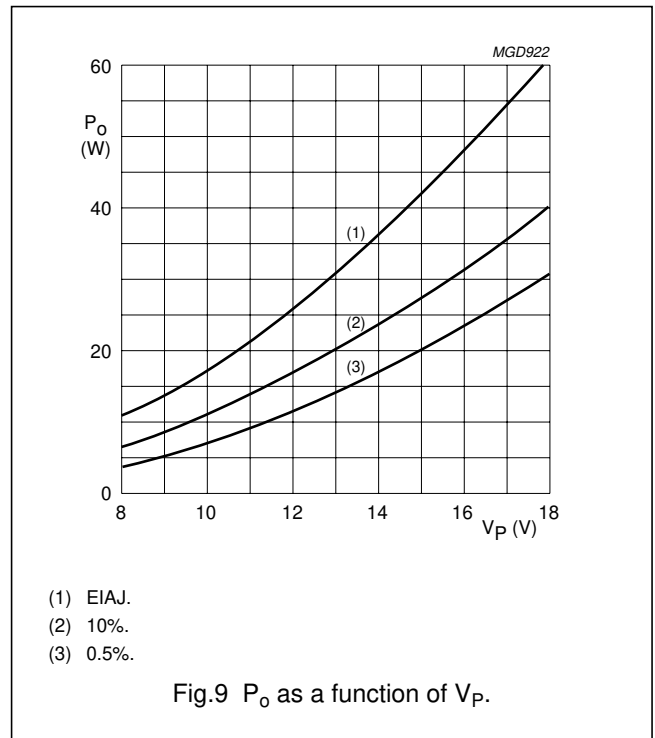
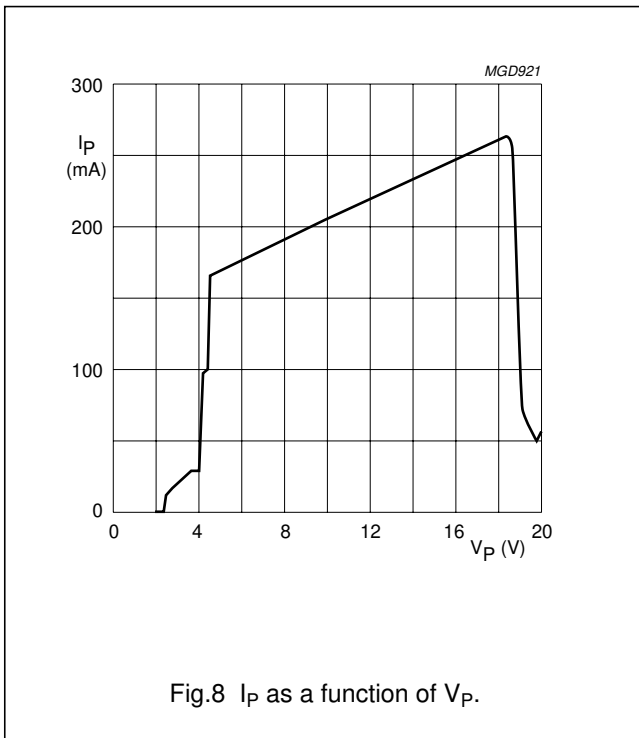# TDA8567Q

TEST AND APPLICATION INFORMATION

Special care must be taken in the PCB-layout to separate pin 9 from the pins 10, 11 13 and 14 to minimize the crosstalk between the clip output and the inputs.

To avoid switch-on plops, it is advised to keep the amplifier in the mute mode during a period of ≥ 150 ms (charging the input capacitors at pin 10, 11, 13 and 14).

Fig.7 Application circuit diagram.

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

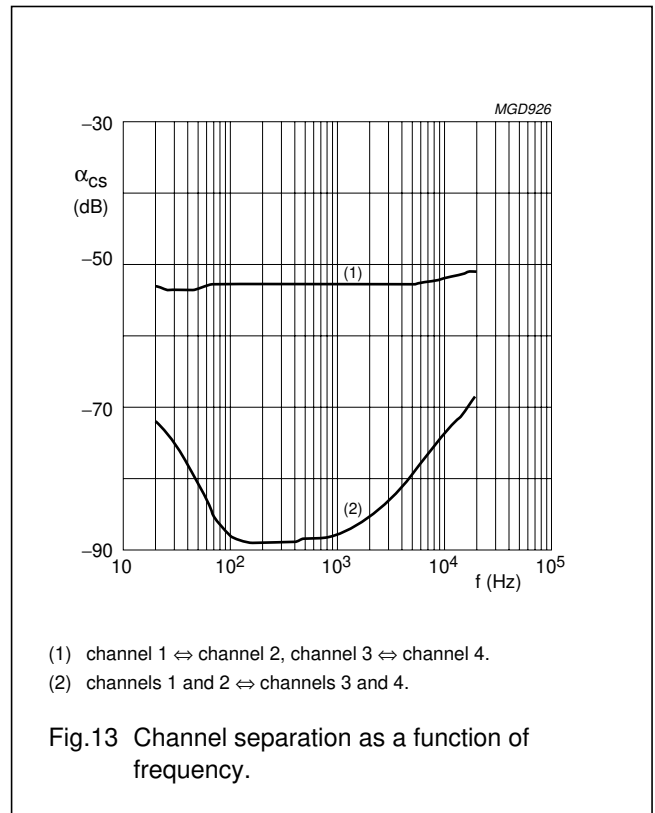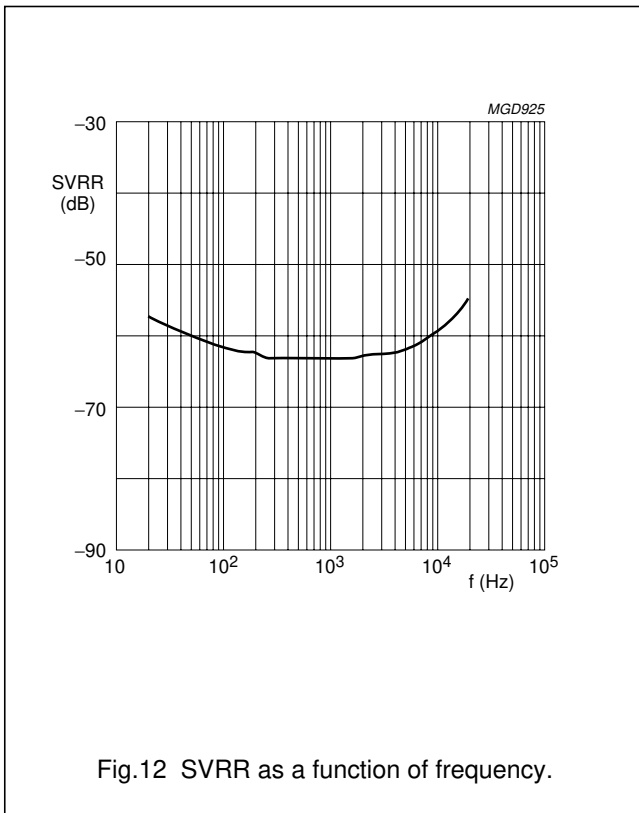### Test information

Figures 8 to 13 have the following conditions: V_P = 14.4 V; R_L = 4 Ω; f = 1 kHz; 80 kHz filter used; unless otherwise specified.

Fig.8 I_P as a function of V_P.

(1) EIAJ.
(2) 10%.
(3) 0.5%.

Fig.9 P_O as a function of V_P.

Fig.10 THD + N as a function of P_O.

Fig.11 THD + N as a function of frequency.

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

Fig.12 SVRR as a function of frequency.

(1) channel 1 ⇔ channel 2, channel 3 ⇔ channel 4.

(2) channels 1 and 2 ⇔ channels 3 and 4.

Fig.13 Channel separation as a function of
frequency.

4 × 25 W BTL quad car radio power amplifier

PCB layout
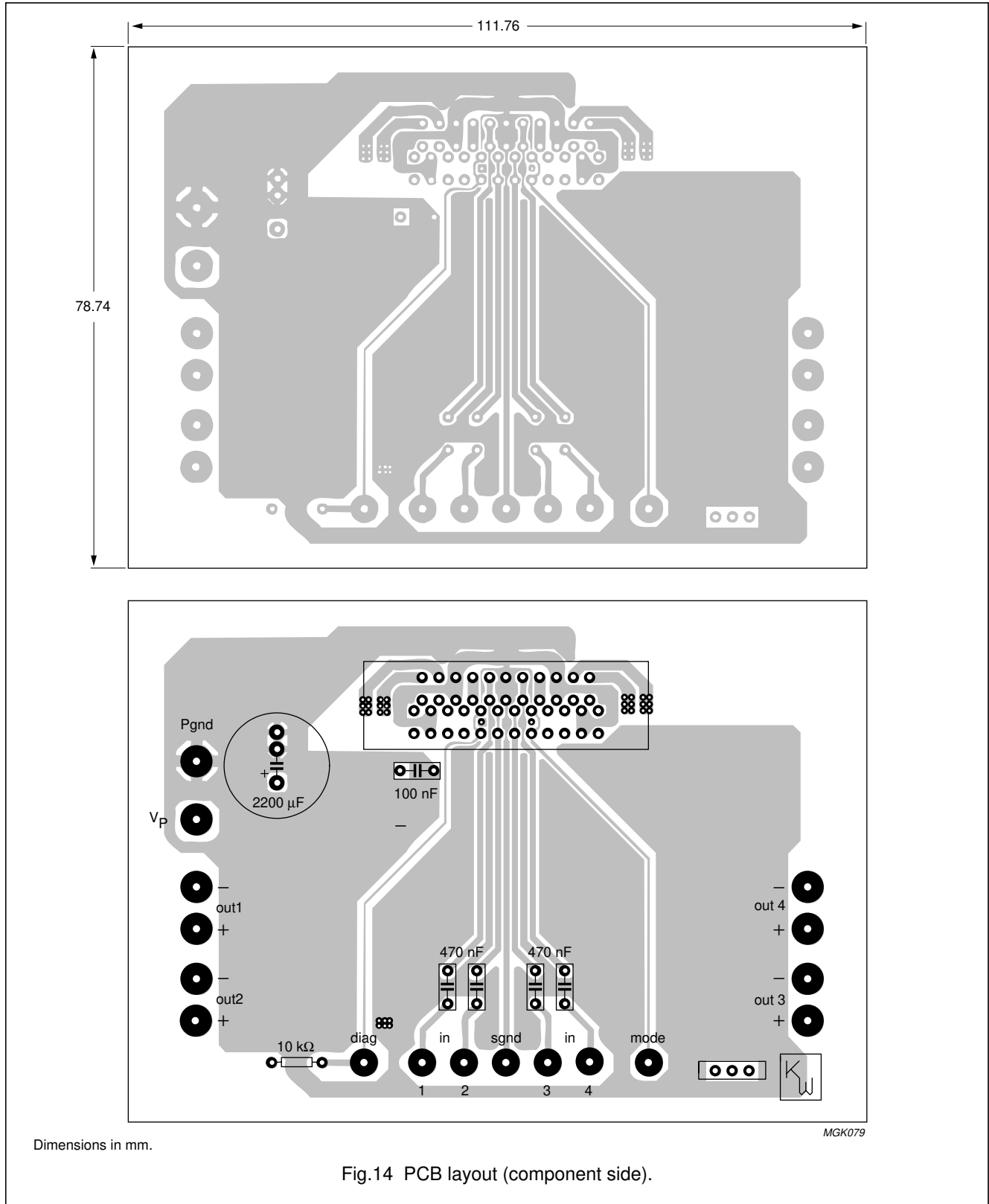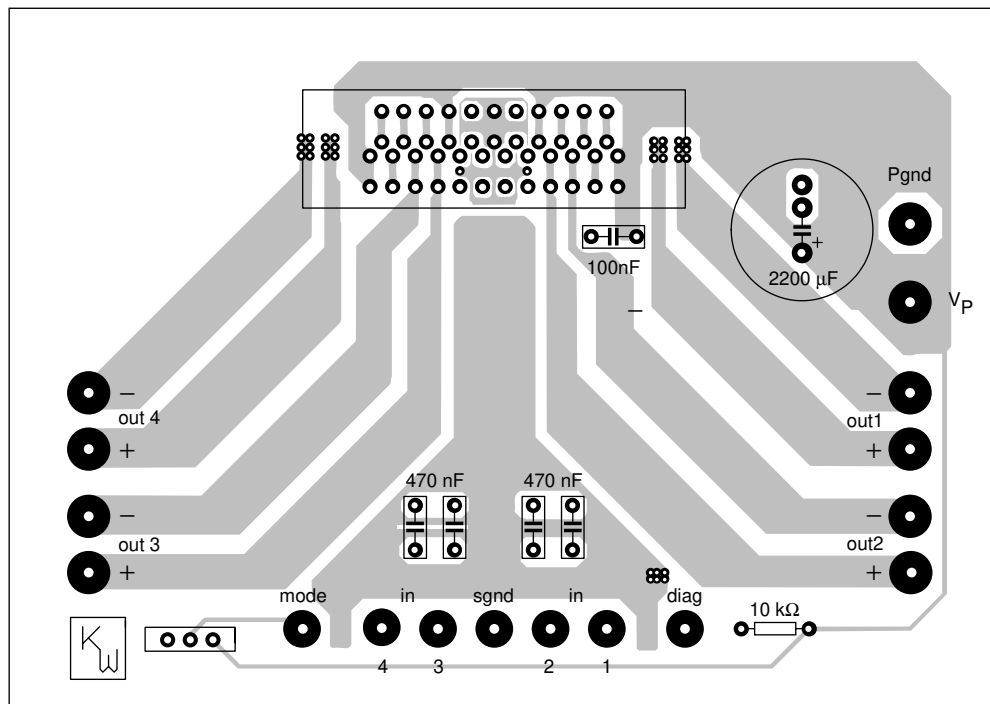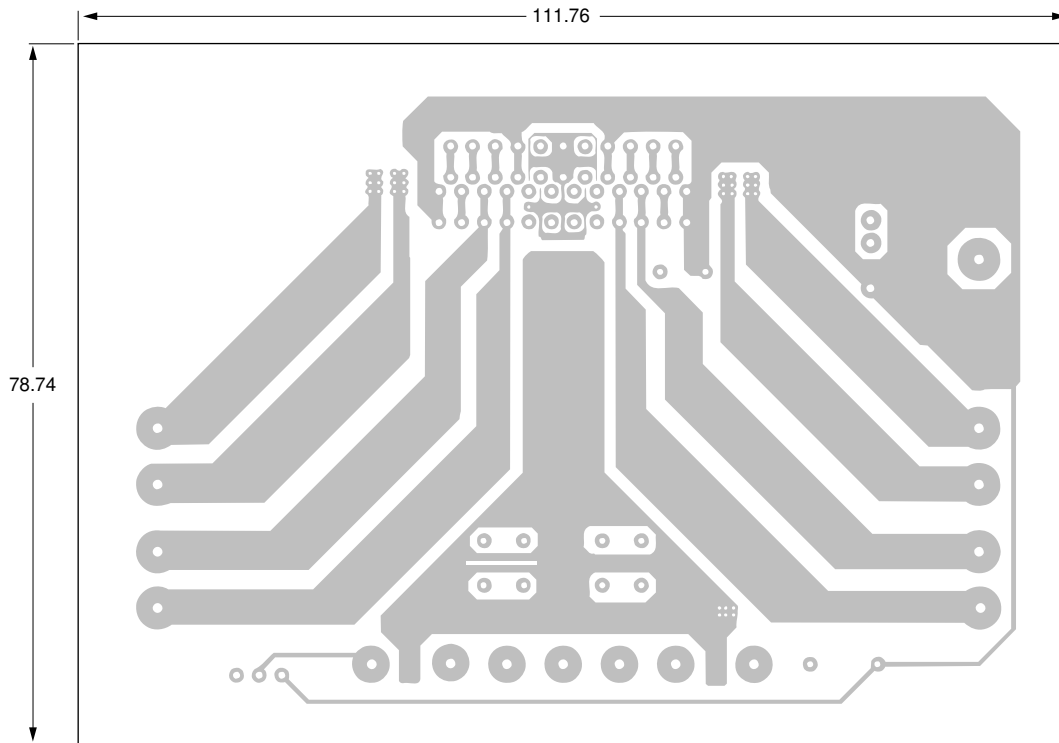

Dimensions in mm.

Fig.14 PCB layout (component side).

MGK079

4 × 25 W BTL quad car radio power amplifier

TDA8567Q

Dimensions in mm.
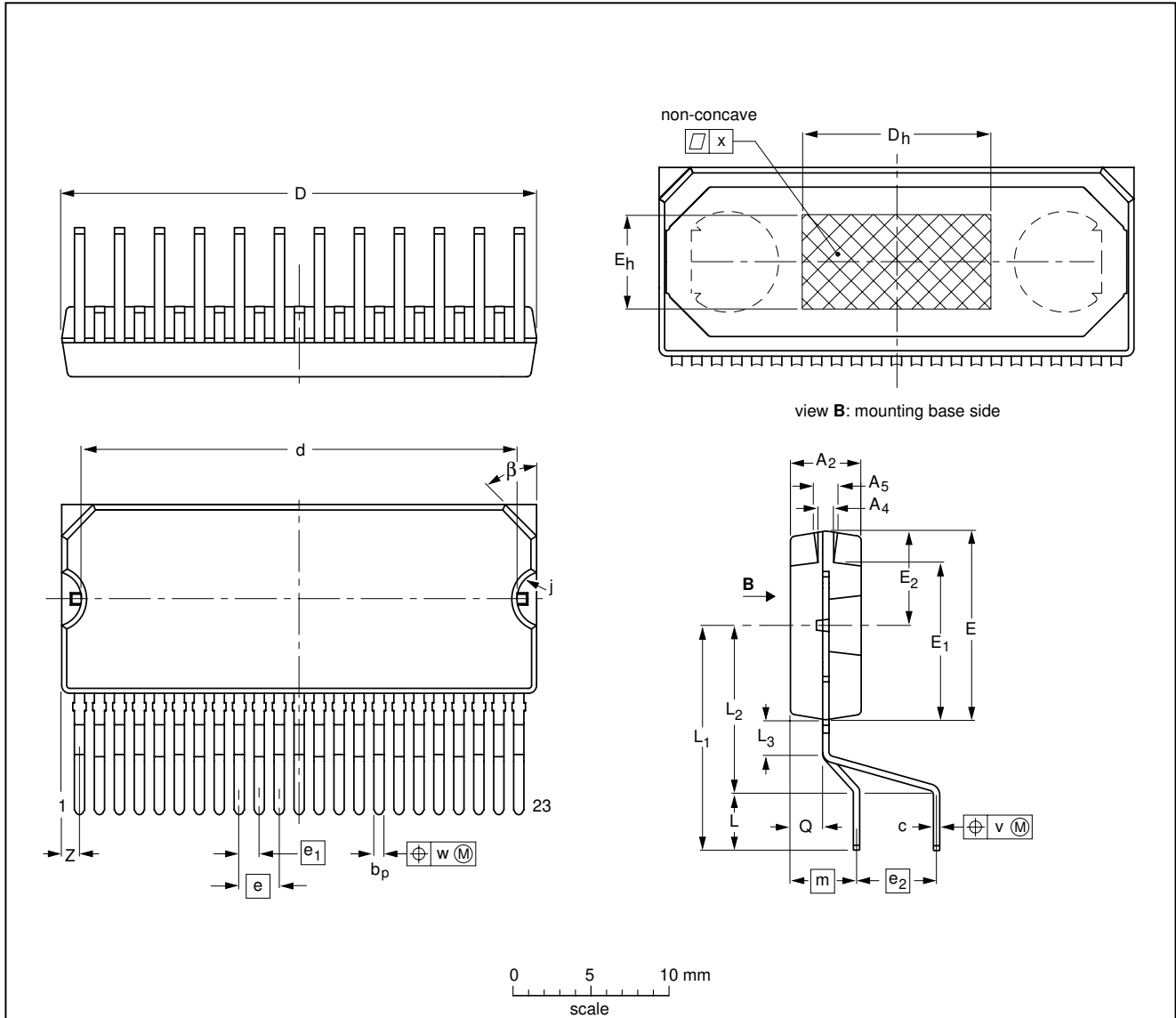
MGK080

Fig.15 PCB layout (soldering side).

PACKAGE OUTLINE

DBS23P: plastic DIL-bent-SIL power package; 23 leads (straight lead length 3.2 mm)   **SOT411-1**

non-concave

D_h

E_h

view **B**: mounting base side

0   5   10 mm
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A_2	A_4	A_5	b_p	c	$D^{(1)}$	d	D_h	$E^{(1)}$	e	e_1	e_2	E_h	E_1	E_2	j	L	L_1	L_2	L_3	m	Q	v	w	x	β	$Z^{(1)}$
mm	4.6 4.3	1.15 0.85	1.65 1.35	0.75 0.60	0.55 0.35	30.4 29.9	28.0 27.5	12	12.2 11.8	2.54	1.27	5.08	6	10.15 9.85	6.2 5.8	1.85 1.65	3.6 2.8	14.0 13.0	10.7 9.9	2.4 1.6	4.3	2.1 1.8	0.6	0.25	0.03	45°	1.43 0.78

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT411-1						~~96-10-11~~ 98-02-20

SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (order code 9398 652 90011).

Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg\ max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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